## EXPRESS MAIL LABEL NO. EV271023835US DATED: 09 JULY 2003

**ATTY DOCKET: GEMF 2048-1** 

#### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of Inventor: William K. Bischel et al.	Group Art Unit:	unknown	
Application No.:	Examiner:	unknowi	
Filed: 09 July 2003 (herewith)			
Title: Multi-Channel Laser Pump Source for Optical Amplifiers	Customer No. 2	2470	

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

#### INFORMATION DISCLOSURE STATEMENT UNDER 37 C.F.R. §1.56

Sir:

It is requested that the information identified in this statement be considered by the Examiner and made of record in the above-identified application. This statement is not intended to represent that a search has been made or that the information cited in the statement is, or is considered to be, material to patentability as defined in 37 C.F.R. 1.56.

Since this is a continuation, divisional or continuation-in-part application, it is understood that the Examiner will consider all information which was considered by the Office in a parent application. MPEP 609.

Enclosed with this statement is a Form PTO-SB08. The Examiner is requested to initial the form and return it to the undersigned in accordance with M.P.E.P. 609.

Copies are not submitted of documents previously submitted by the applicant in parent Application No. 09/784,687 filed 14 February 2001, Attorney Docket No. GEMF 2048-0, from which benefit under 35 U.S.C. 120 is claimed, 37 C.F.R. 1.98(d)(1), with an information disclosure statement submitted in the parent application which complies with the Sept. 8, 2000 or subsequent revision of 37 C.F.R. 1.98(a-c).

This statement should be considered under 37 C.F.R. 1.97(b) because it is being filed within three months of the filing date of an application other than a continued prosecution application under 37 C.F.R. 1.53(d).

Fee Authorization. The Commissioner is hereby authorized to charge underpayment of any additional fees or credit any overpayment associated with this communication to Deposit Account No. 50-0869 (GEMF 2048-1). A duplicate copy of this authorization is enclosed.

Respectfully submitted,

HAYNES BEFFEL & WOLFELD LLP

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7/9/2003

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Application Number	T					
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First Named Inventor	Willam K. Bischel et al.					
Group Art Unit						
Examiner Name						
Attorney Docket Number	GEMF 2048-1					

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-	U.S. PATENT DOCUMENTS									
Examiner Initials	Cite No.1	U.S. Patent Document  Number  Kind Code (if known)	Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	Pagès, Columns, Lines, Where Relevant Passages or Relevant Figures Appear					
	A21	6,343,171	Yoshimura et al.	01-29-2002						
	A22	6,445,841	Gloeckner et al.	09-03-2002						
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Examiner Initials	Cite No.1	Office <sup>3</sup>	Number <sup>4</sup>	Kind Code <sup>5</sup> ( <i>if known</i> )	Applicant of Cited Document	Cited Document MM-DD-YYYY	Passages or Relevant Figures Appear	T6		
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<sup>&</sup>lt;sup>1</sup> Unique citation designation number. <sup>2</sup> See attached Kinds of U.S. Patent Documents. <sup>3</sup> Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). <sup>4</sup> For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. <sup>5</sup> Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. <sup>6</sup> Applicant is to place a check mark here if English language Translation is attached.

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-	A2	5,179,609	Blonder et al.	01-12-0993					
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Examiner Initials*	Cite No.1	Office <sup>3</sup>	Foreign Patent Doc Number <sup>4</sup>	ument Kind Code <sup>5</sup> (if known)	Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	T		
	B1	,	WO 02/06560	00	Gemfire Corp.	08-22-2002				
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STA	TEMENT B	Y APPLICANT	First Named Inventor	Willam K. Bischel et al.			
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-,		OTHER PRIOR ART NON PATENT LITERATURE DOCUMENTS	
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. 99	C1	ARMIENTO, C.A. et al., "Passive coupling of InGaAsP/InP laser array and singlemode fibres using silicon waferboard," Electronics Letters 27(12) (06/10/1991) 1109-1110, IEEE.	
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